

101385C

FB68.0625-1.625 68.0625 MHz Bandpass Filter 1.625 MHz Bandwidth

Specifications

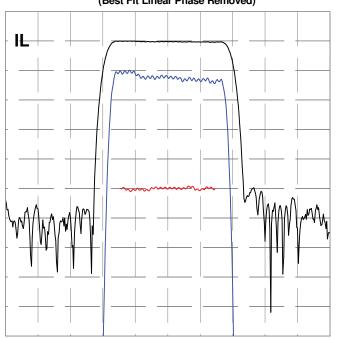
Parameter	Symbol	Min	Typical	Max	Unit
Center Frequency	F ₀		68.0625		MHz
Bandwidth	В		1.625		MHz
-3 dB Bandwidth	В3	1.9	1.9		MHz
-40 dB Bandwidth	B ₄₀		2.3	2.3	MHz
Delay	T ₀	7.04	7.062	7.08	µsec
Insertion Loss	IL		23.7	33.5	dB
Amplitude Ripple			0.4	1	dB_{P-P}
Phase Ripple			2.1	4	deg _{P-P}
Rejection		50	54		dB
Spurious for $ t - T_0 > .9T_0$			-46	-44	dB
Substrate Material	40YX-Q				

Notes

- 1. Center Frequency (F₀) and Bandwidth (B) are defined, not measured.
- 2. Insertion Loss is the minimum loss for $|f F_0| < .5B$
- 3. Ripple spec applies to the $|f F_0| < .4B$, and is doubled for $.4B < |f F_0| < .5B$
- 4. Rejection spec applies to $(B_{40} \text{ Spec} B/2) < |f F_0| < F_0/2$
- 5. Specifications are at 22 °C only. Unit will operate undamaged from -54 °C to 125 °C with shifts $dF_0 = -x * F_0$, $dT_0 = x * T_0$, where $x = 3E-8 * (temperature 22 °C)^2$

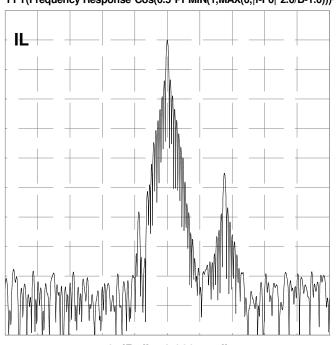
Typical Performance

Frequency Response (Best Fit Linear Phase Removed)



10 dB/div, 1 dB/div, 10 deg/div, 0.500 MHz/div

Impulse ResponseFFT(Frequency Response*Cos(0.5*PI*MIN(1,MAX(0,|f-F0|*2.0/B-1.0)))^2)



10 dB/div, 8.000 us/div



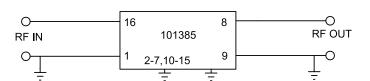
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Package Outline

2.095±.020 -SERIAL NO. *Microsemi* XXX-.750±.020 6Y858 XXXX-101385 DATE CODE .175±.010 .16 MIN 1.400 .600±.010 .100 TYP. 10 9 16 15 14 13 12 11

Matching





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